

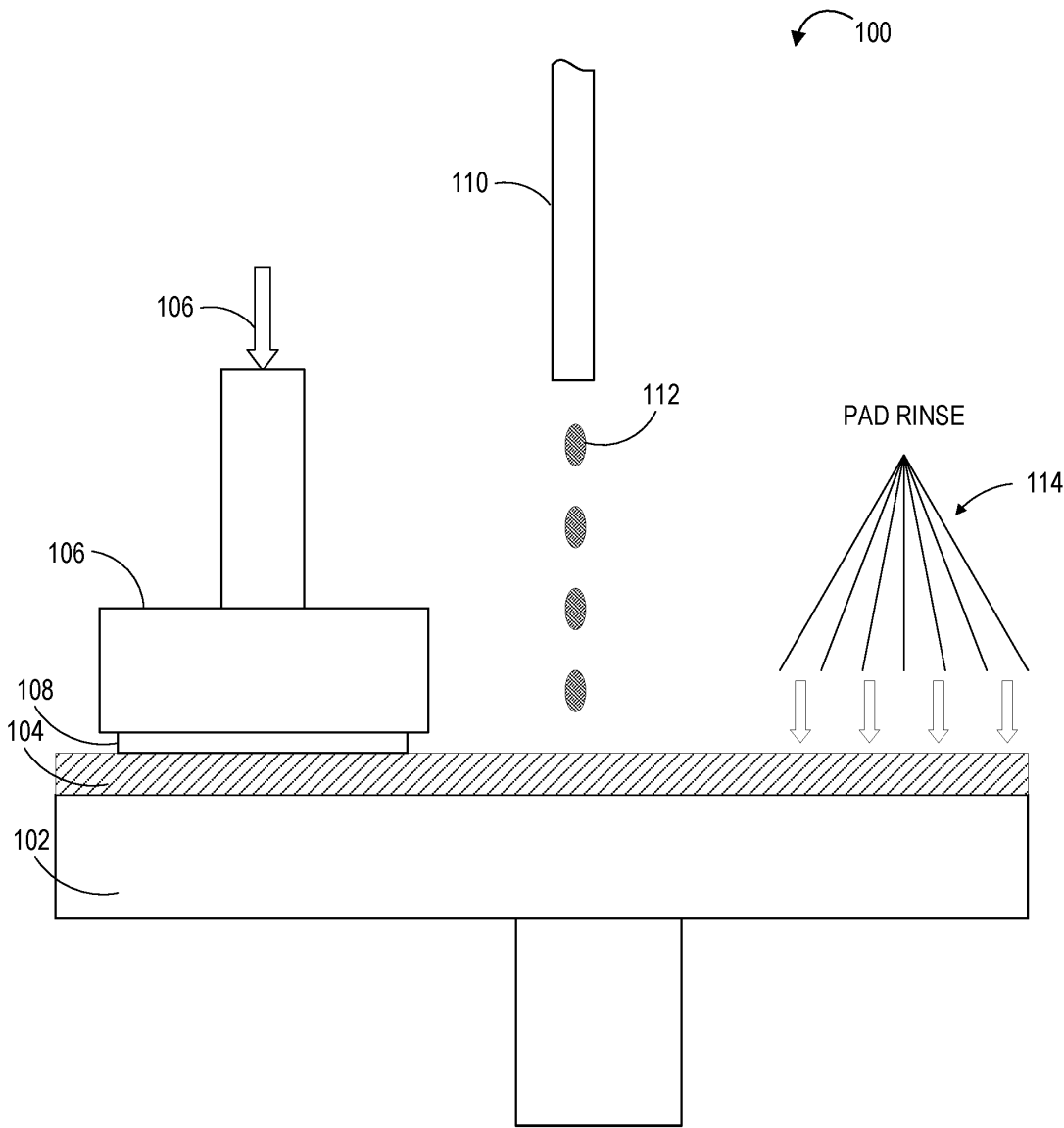


FIG. 1

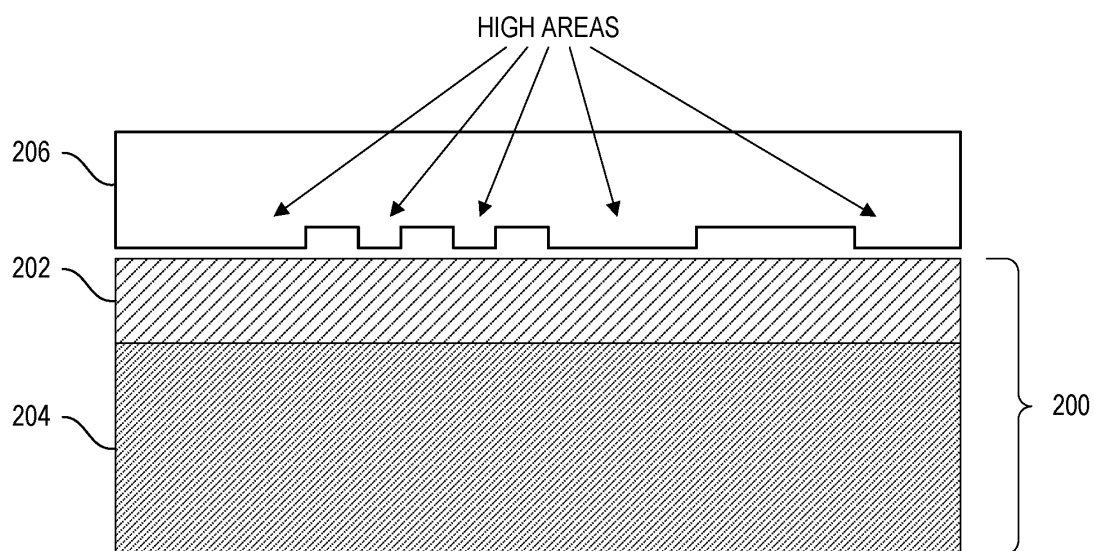


FIG. 2

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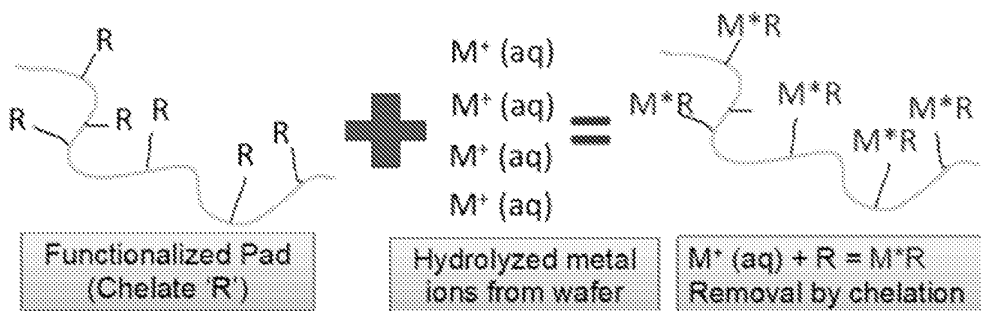
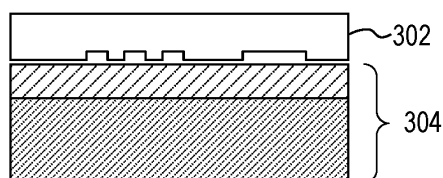
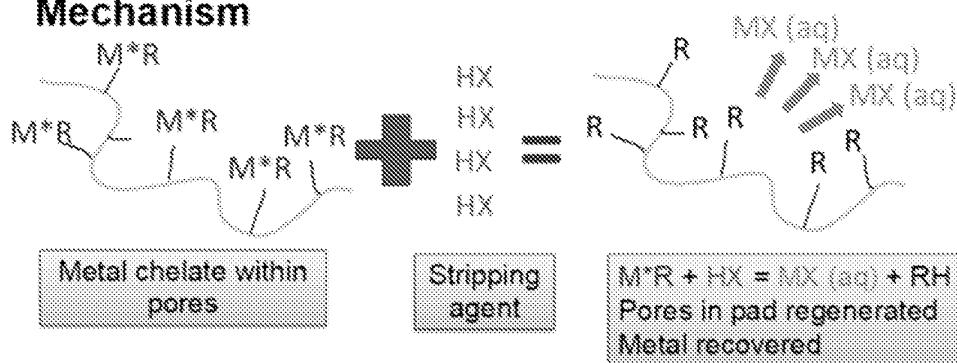
Mechanism**Polish Schematic**

FIG. 3

Mechanism**Regeneration Schematic**

Stripping agent dispensed to regenerate pad post wafer polish

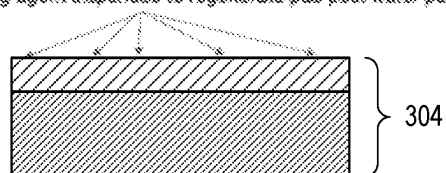


FIG. 4

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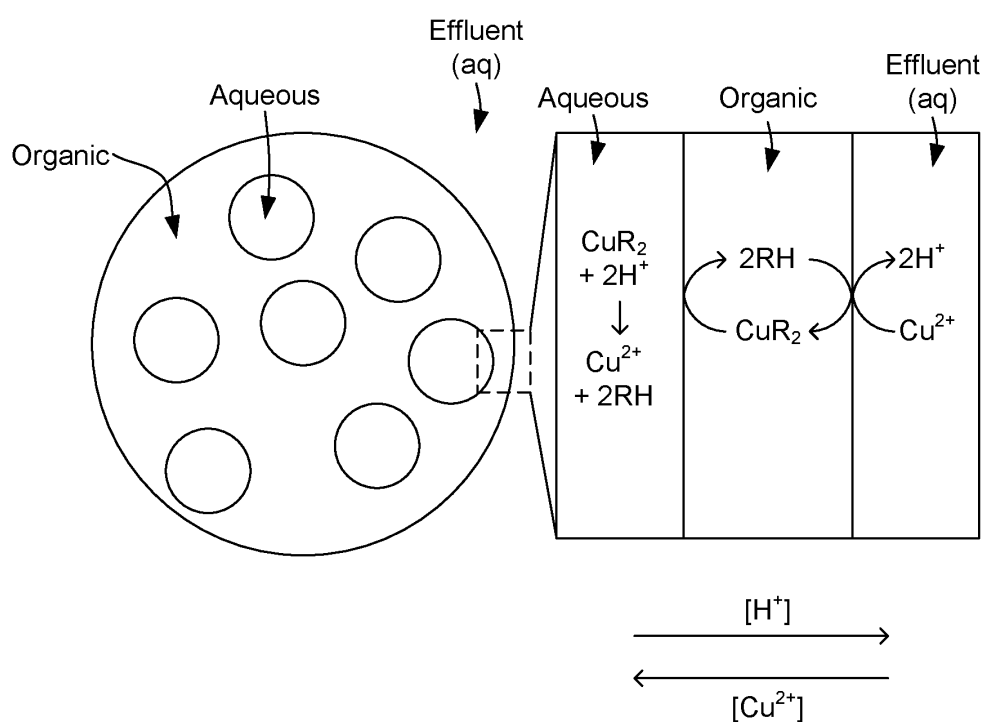


FIG. 5

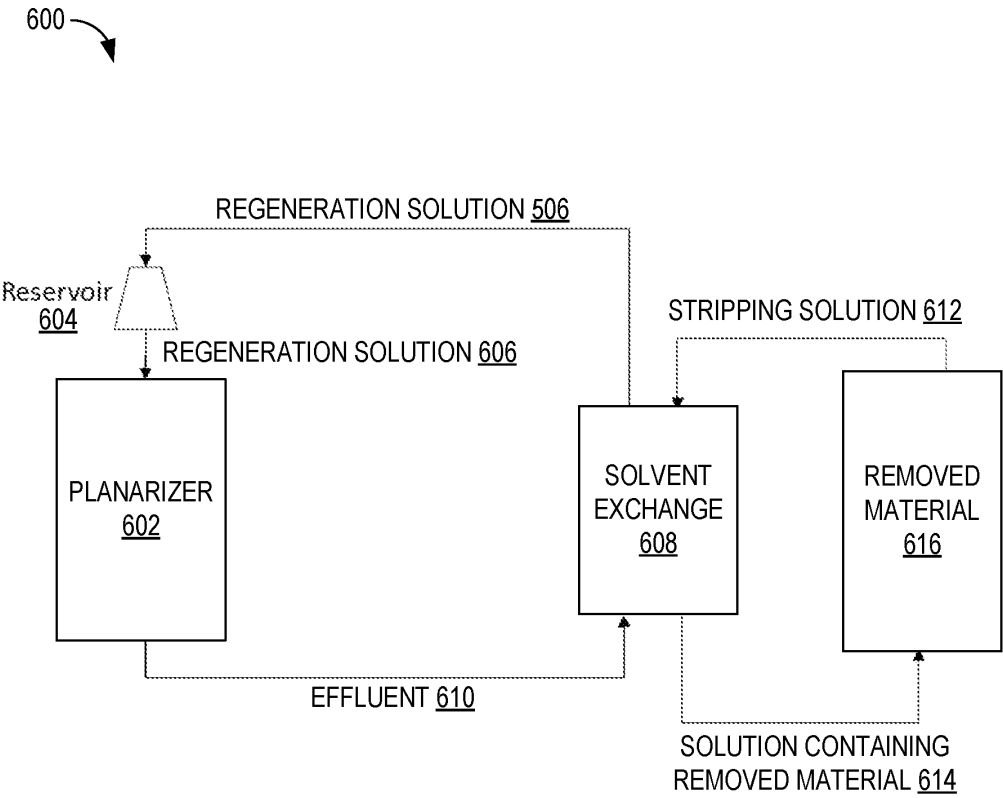


FIG. 6

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700

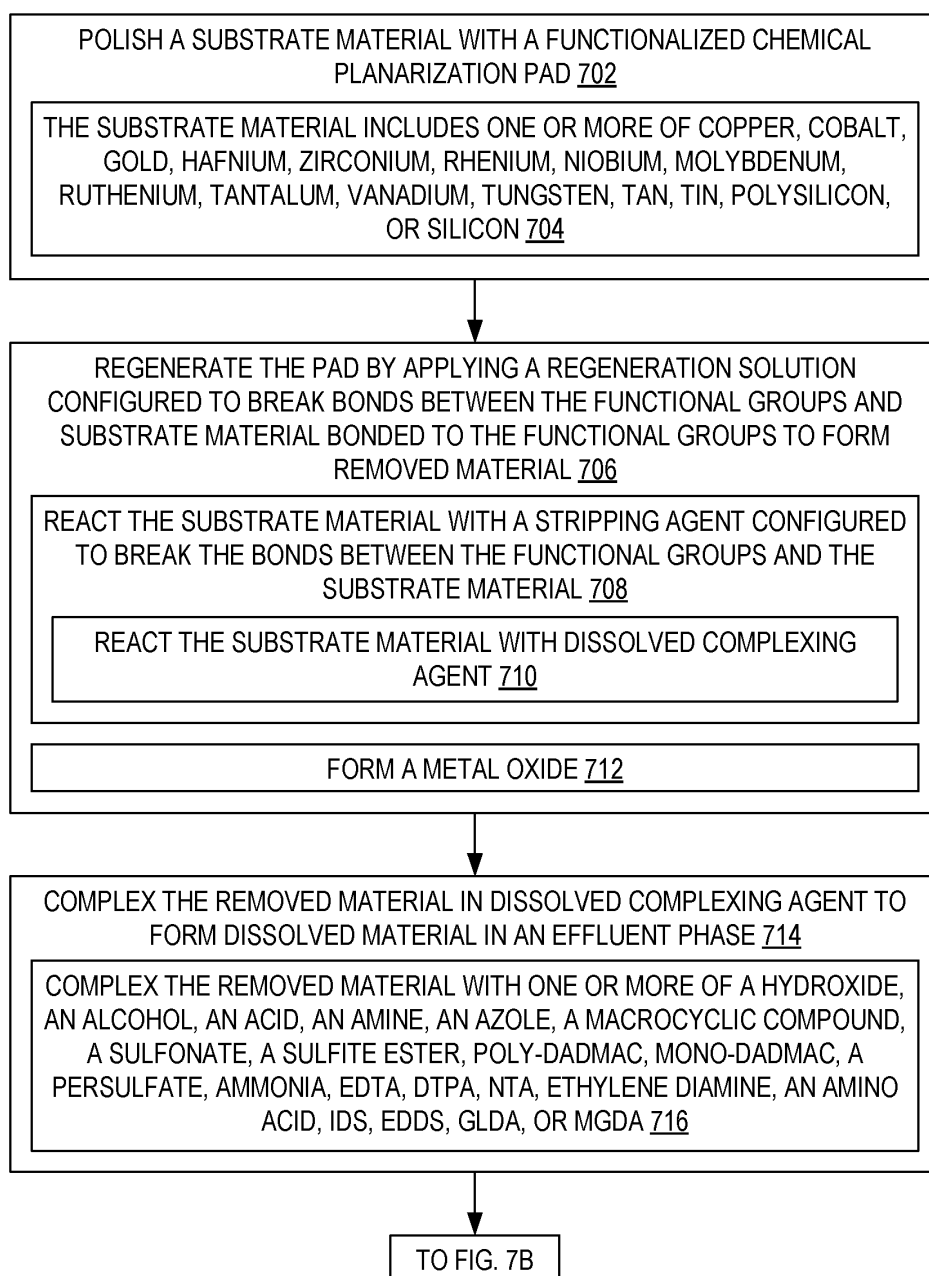


FIG. 7A

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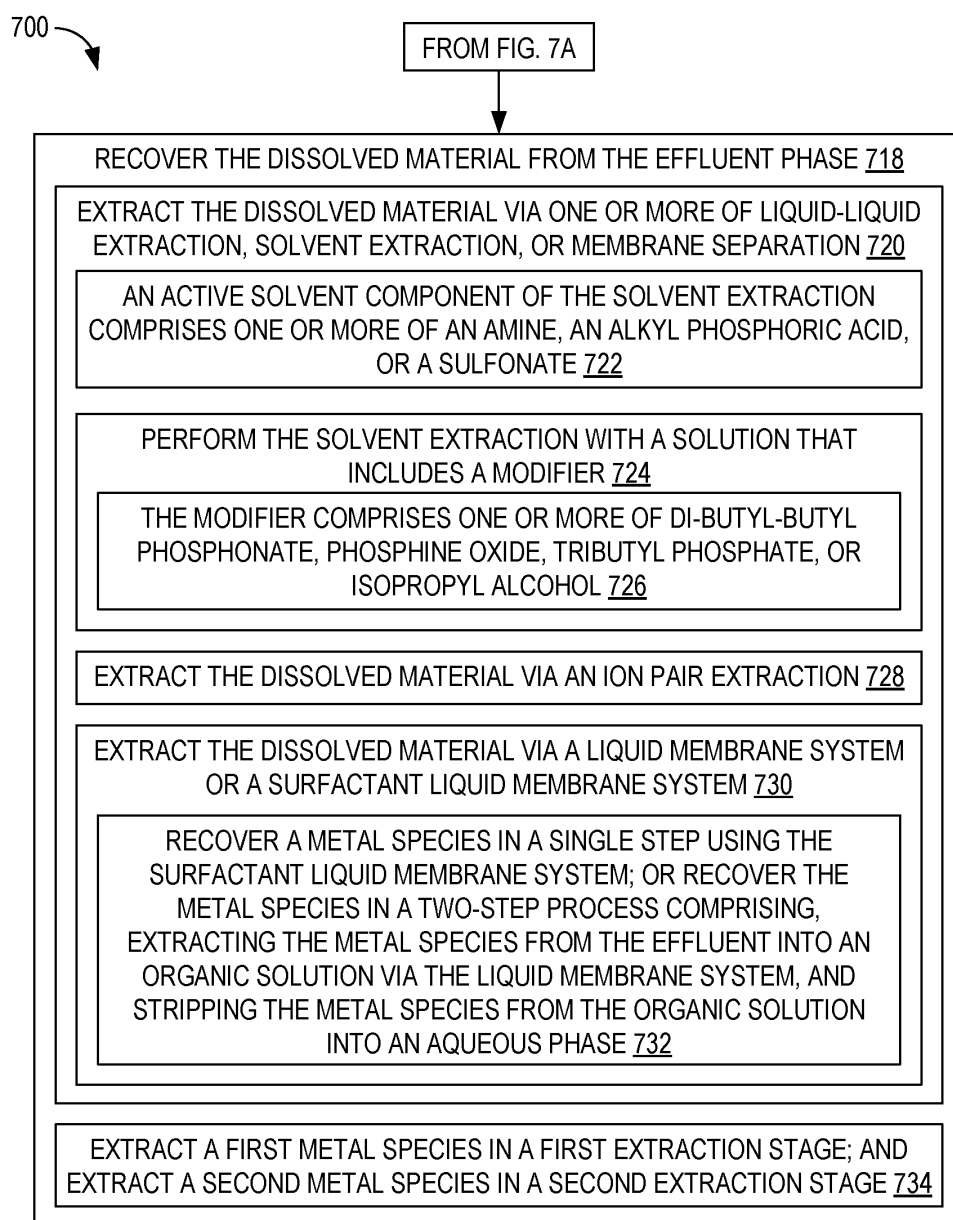


FIG. 7B